

RISC-V of Samsung in the age of 5G and AI

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RISK of Samsung

SAMSUNG
Electronics

Since 1969

1974

1983

1997

2002

2006

2015

2019

2069

Memory

Semiconductor

System LSI

External RISK

RISK !!!

Change Everything !!!

Internal RISK

RISK !!!

Nov. 1st, 2019

50th Birthday

50 to 100

Display
Driver
IC
No.1

MP3
AP
No.1

Navigation
AP, SIM
No.1

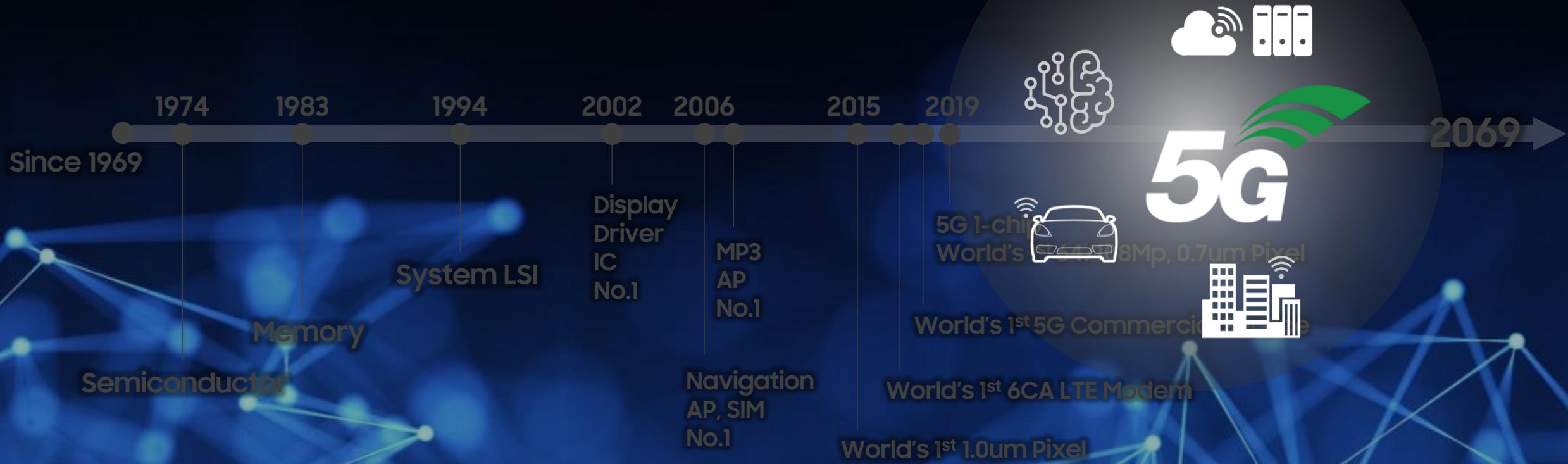
5G 1-chip
World's 1st 64/108Mp

World's 1st 5G Commercial Service

World's 1st 6CA LTE Modem

World's 1st 1.0um Pixel

RISK of Samsung in the age of 5G and AI



RISC-V of Samsung in the age of 5G and AI



Samsung Electronics

Consumer Electronics

Visual Display



Digital Appliances



IT & Mobile

Mobile Communications



Networks

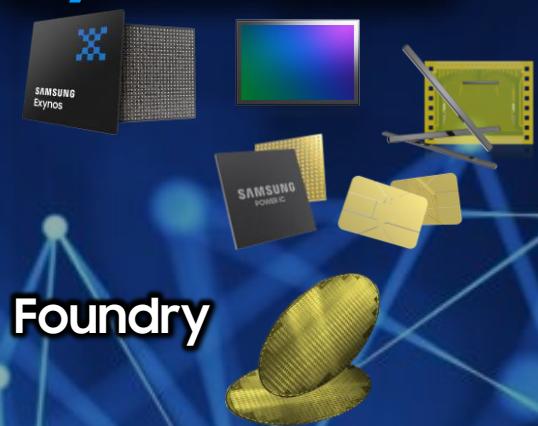


Device Solution

Memory



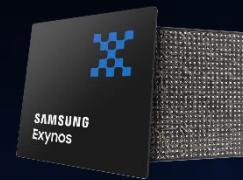
System LSI



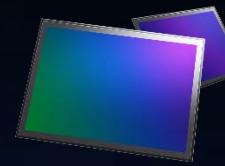
Foundry

System LSI

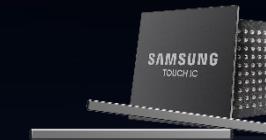
Unique Fabless
with Wide Range of Products



SoC
AP/Modem/RF/
Connectivity



CMOS
Image Sensor



Display Driver IC
Touch Controller



NFC/eSE/SIM
Banking/ID



Power
Management IC



DTV SoC

Mobile Devices



Consumer Devices



Automotive



Age of 5G

The Mass Connected Era

Inspires creativity to all connected dots



5G

2018

3GPP 5G NR Phase 1
Standard Release

2019

Commercial Device
& Service Release

2020

5G NR
Commercialization

Enhanced Mobile Broadband
Ultra Reliable & Low Latency
Massive Machine Type Communication

Throughput
&
Latency

**5G Mobile Subscriptions to
Reach 1 Billion by 2023**

(Ericsson Mobility Report, Nov.2017)

Cellular Modem

600 million+

Exynos Modems have been commercialized

in **150 Countries**



2009
Released World 1st Commercial LTE Modem

LTE Advanced



Exynos Modem 300/303

2014
300Mbps Carrier Aggregation

2017

1Gbps LTE Cat.16

2018

1.2Gbps LTE Cat.18

2019

2Gbps LTE Cat.18

2020

LTE Advanced Pro



Exynos 8895
Exynos Modem 359



Exynos 9810
Exynos 9610



Exynos 9820



Exynos Modem 5100

FRI 2Gbps, FR2 6Gbps



Exynos Modem 5123

FRI 5.1Gbps, FR2 7.35Gbps
SA/NSA, EN-DC



Exynos 980

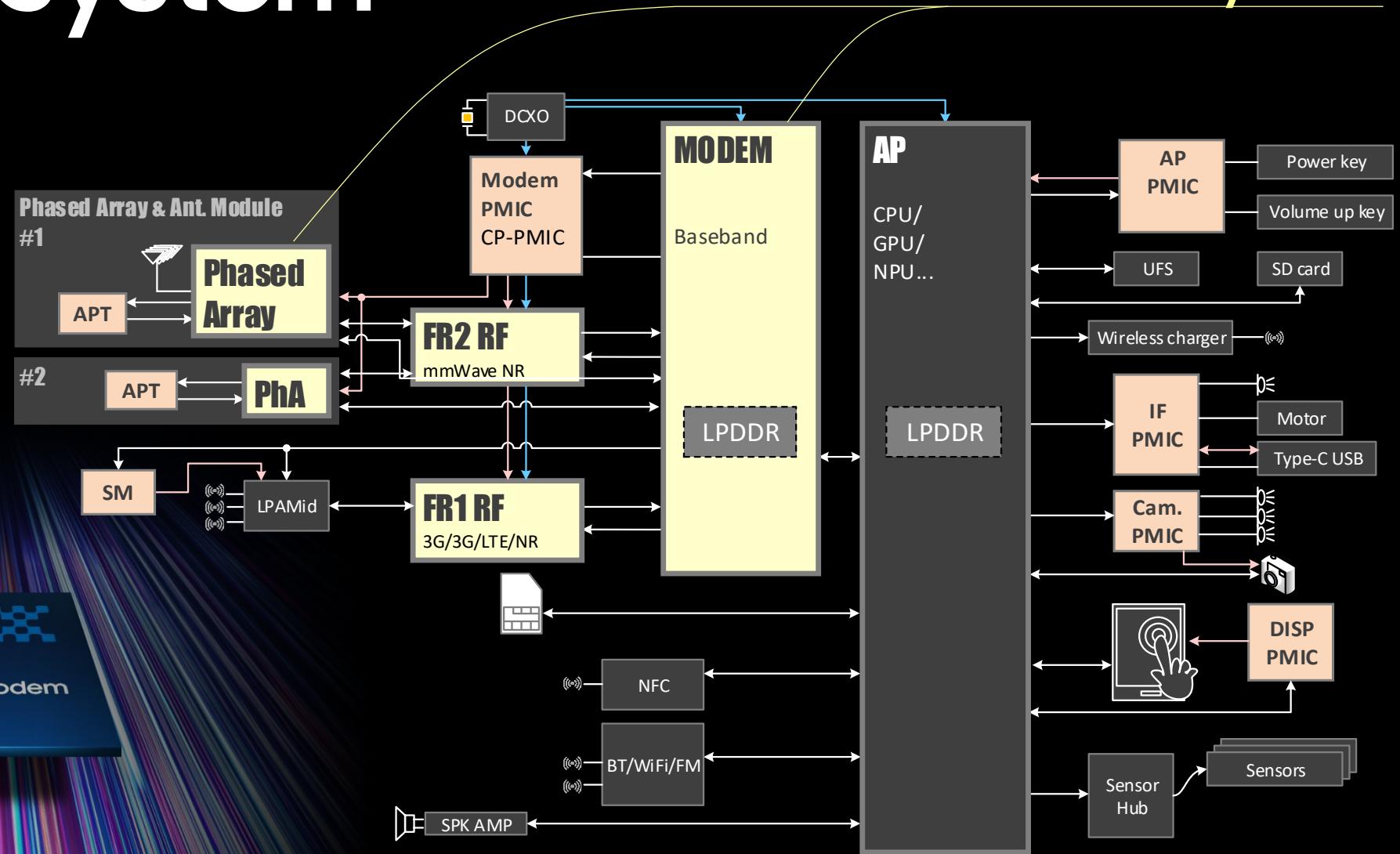
5G 1 Chip SOC
FRI 2.55Gbps~ 3.55Gbps
SA/NSA, EN-DC

5G NR Rel.15 Compliant
Multi-mode 5G Chipset Series

5G New Radio

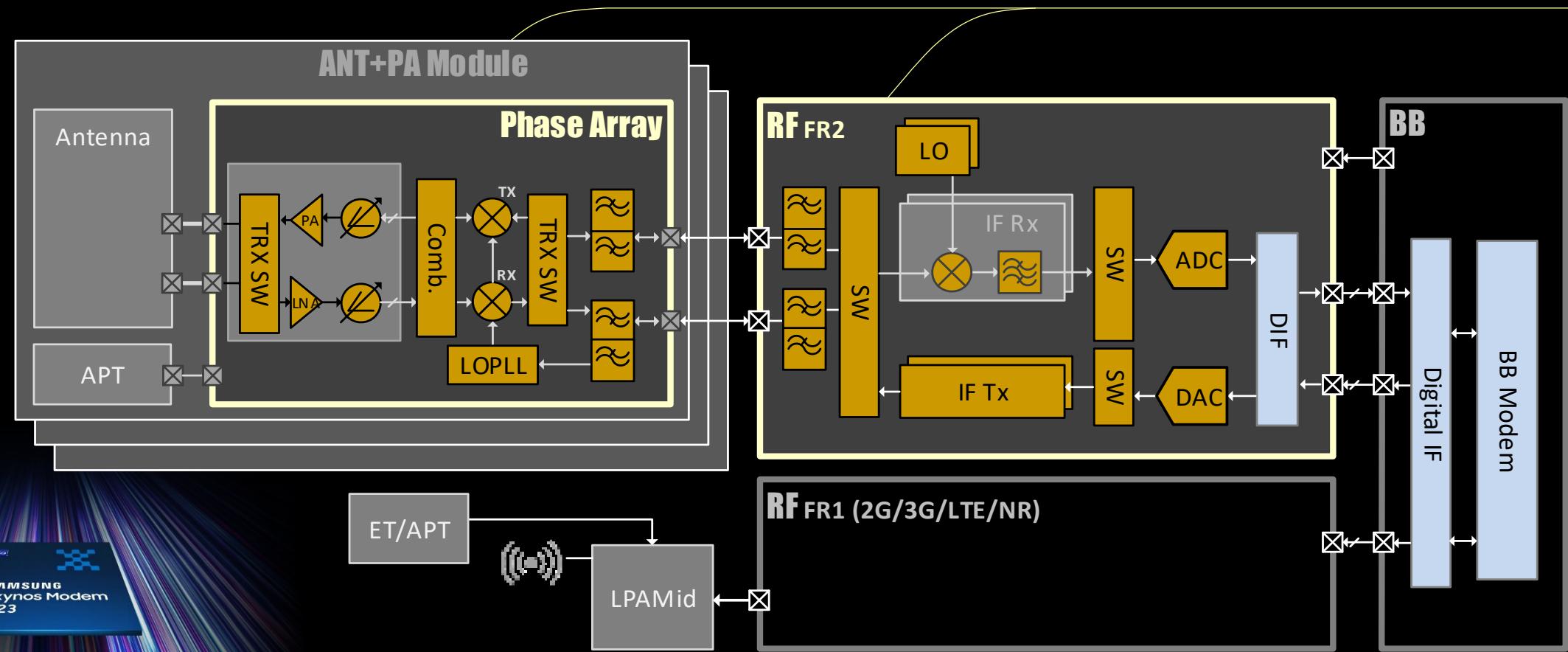
Exynos System

5G Modem System



Exynos RF System

mmWave RF



RISC-V in 5G

RISC-V in mmWave RF

[2017] The 1st RFIC test chip was taped out

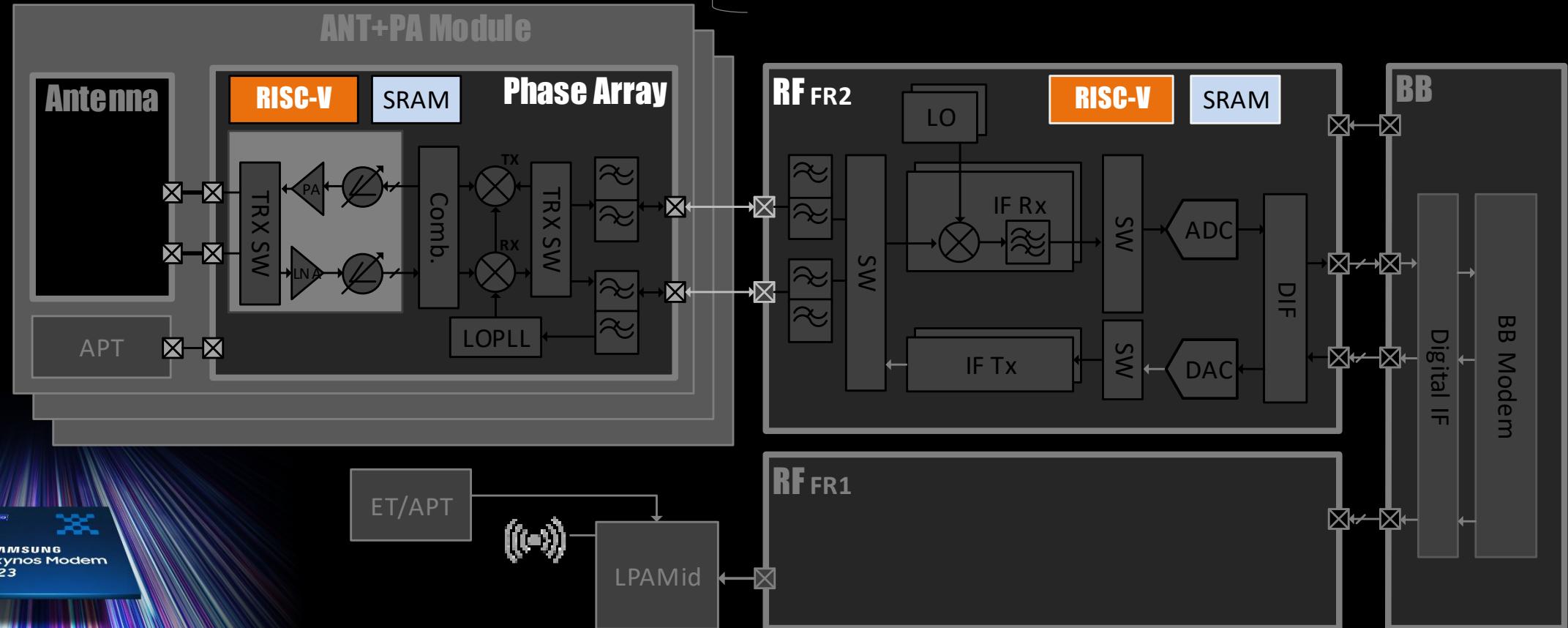
- Offset calibration

[2018] The 1st generation (center / phased array) RFICs were taped out

[2018] The 1st multiple band phased array RFIC was taped out in 2018.

[2019] The 2nd center RFIC were taped out

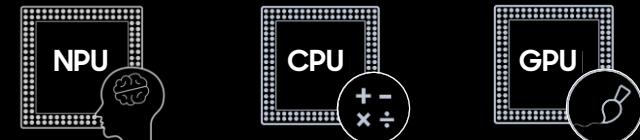
[2020] Plan to adopt in the flagship mobile devices in 2020.



Age of AI

AI/Deep Learning through the Industries

On-device intelligence combining with 5G, IoT
brings the innovation in everyday life and services,
which is enabled by advanced semiconductor technologies



AI Accelerator



Exynos for Device Intelligence

Neural Processing Unit

An Intelligent Powerhouse

High Performance,
Low Power Processing

Intelligent
Image Processing



Flexible and Scalable
Architecture

Face/Object/Voice
Recognition

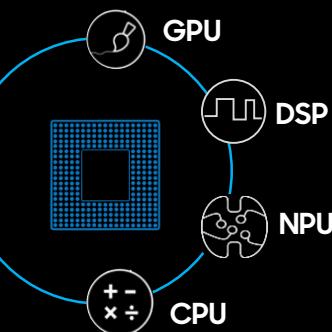


Android NN API,
Caffe2, Tensorflow-lite

IoT/Machine
Learning



Smart
Mobility



Intelligent Camera

Powered by ISOCELL
image sensors

Ultra-high Resolution

More Pixels in a Small Sensor

Small and Slim

Tiny Camera Fit for Full Front Display

Intelligent Camera

Scene-Adaptive HDR Processing,
Face Detection/Recognition, Fast AF

Multiple Cameras

Dual, Triple and Quad Cameras
for Various User Scenarios

High Light-sensitivity

Bright and Clear Image under Low Light

3D Depth Sensing

DVS, ToF for Game, VR/AR



*DVS - Dynamic Vision Sensor

*ToF : Time-of-Flight

RISC-V in Sensors

Competitiveness

Scalable and Flexible design options

Open Source ISA

Matured core designs available

SW eco built-up

Image Sensor IC

Large variant of requirements based on applications

Different resolution, frames, pre-processing, precisions, etc.

Development of large number of line-ups in parallel

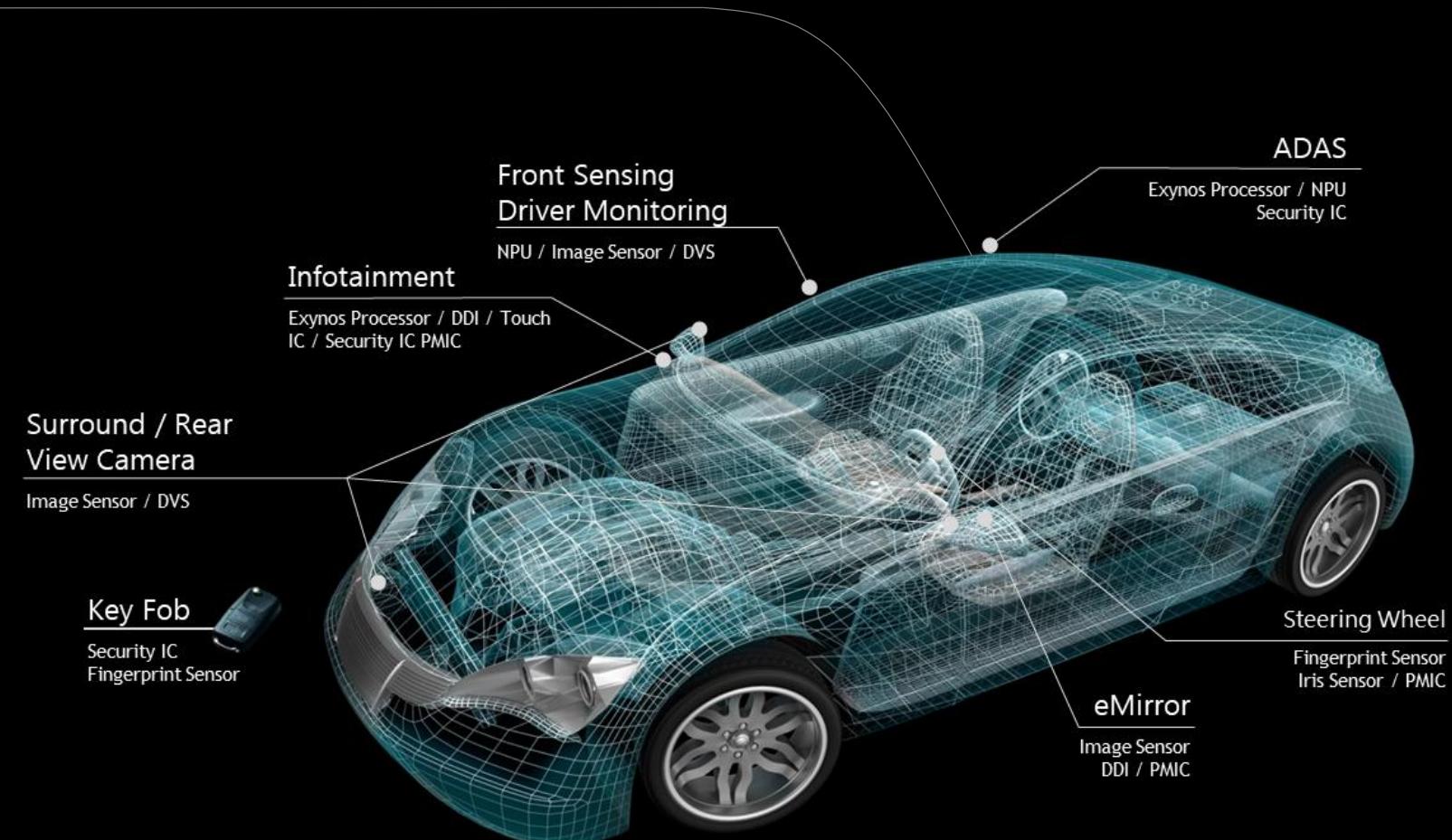
Development environment and base HW/SW design must be unified, regardless of varying requirements and specifications

RISC-V base environment with base ISA, additional project-dedicated features with applicable extensions

Intelligent Driving Experience

AI accelerated SOC and Sensors

Exynos Auto for Infotainment
Exynos Modem for Telematics
Exynos Auto for ADAS
ISOCELL Image Sensor



RISC-V of Samsung

5G Modem RF

AI Image Sensor

MOBILE

AI Computing and Control
RF Calibration and Control
Security Management

AUTOMOTIVE

AI Computing and Control
Security Management
Safety Island

Next Generation System Architect

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SYSTEM LSI